



SUA-110M4x-x-S235

Shell Material :

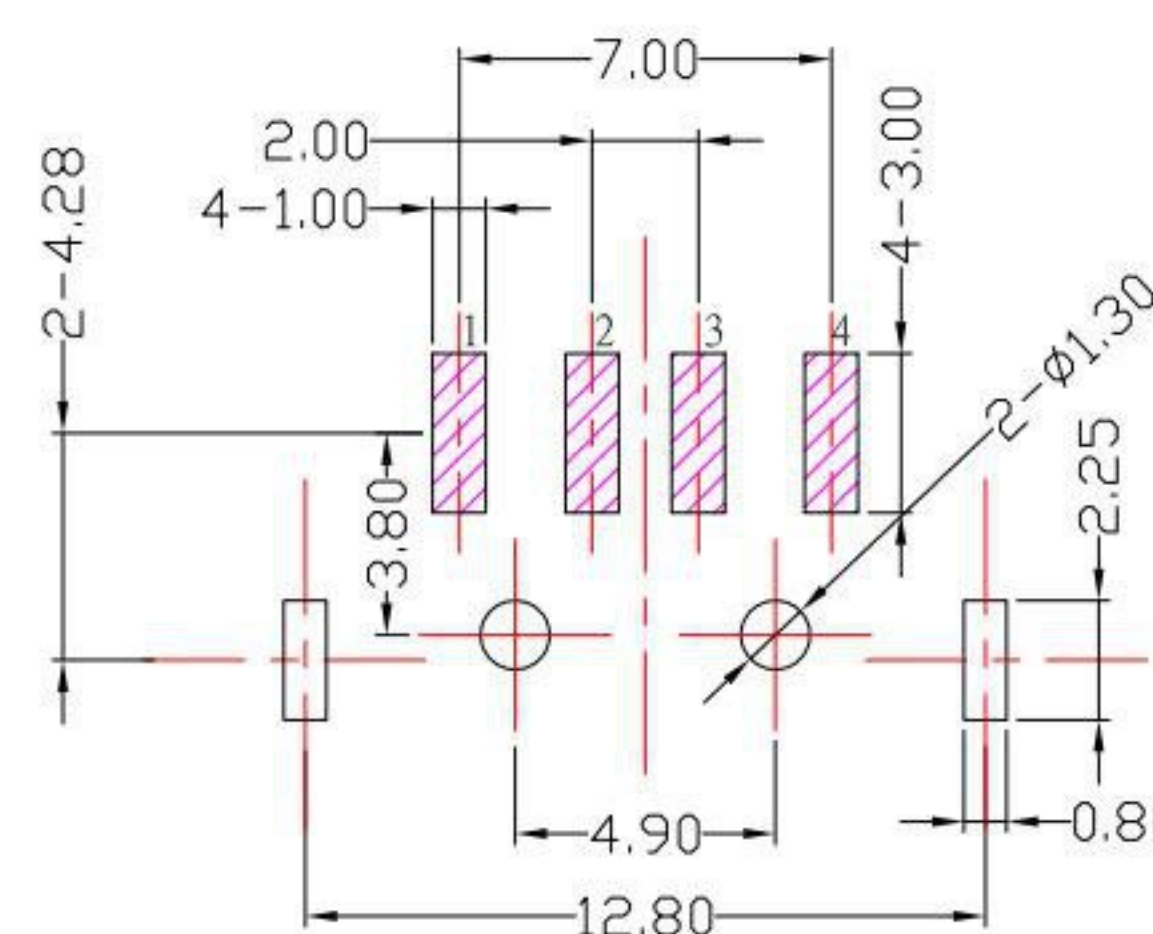
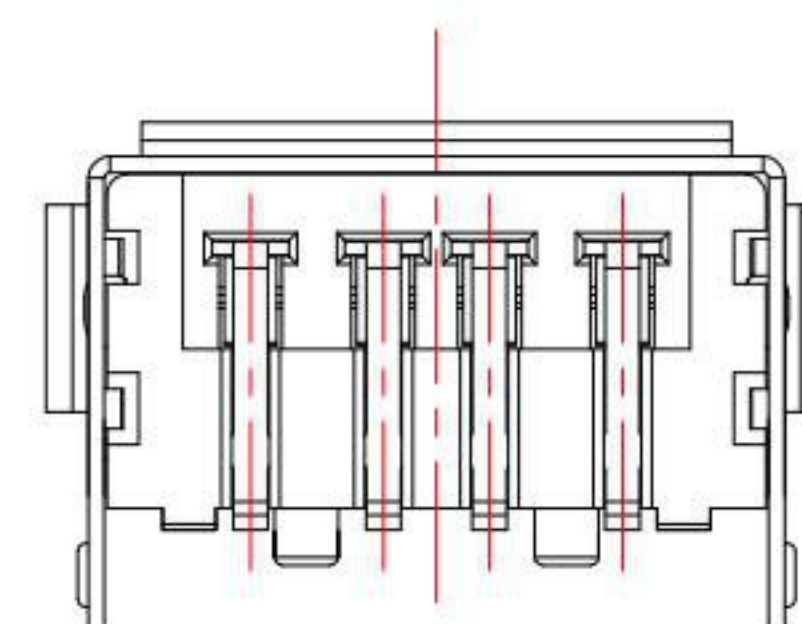
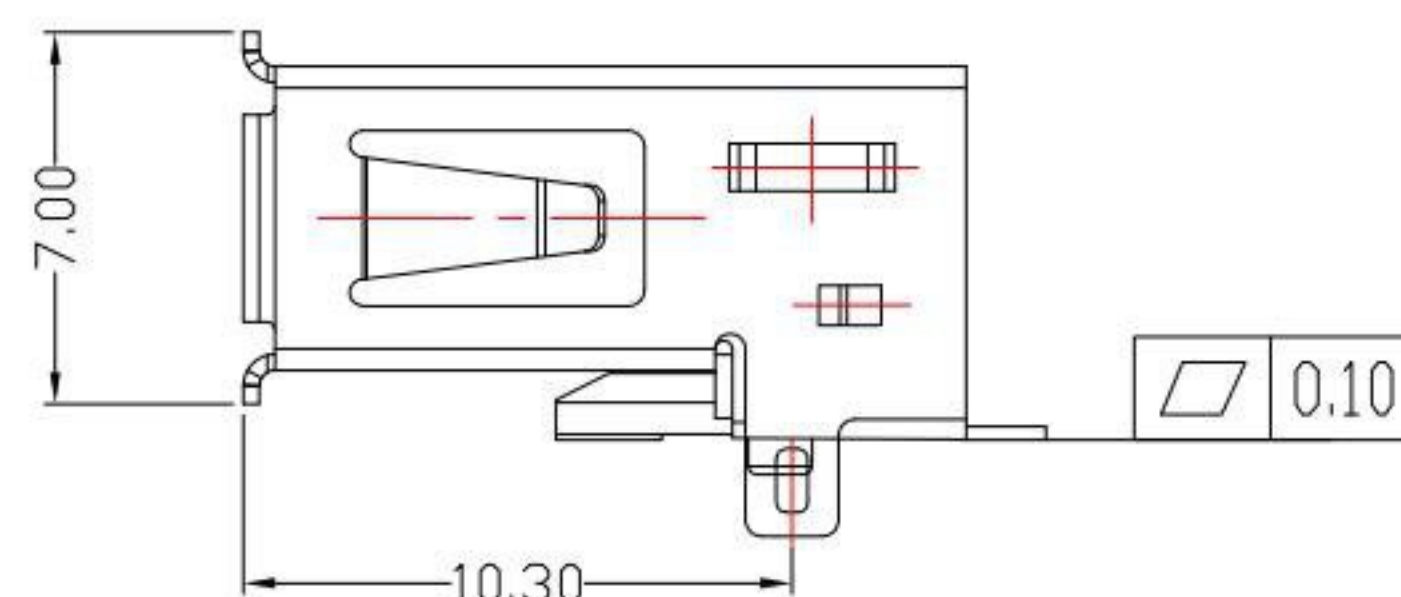
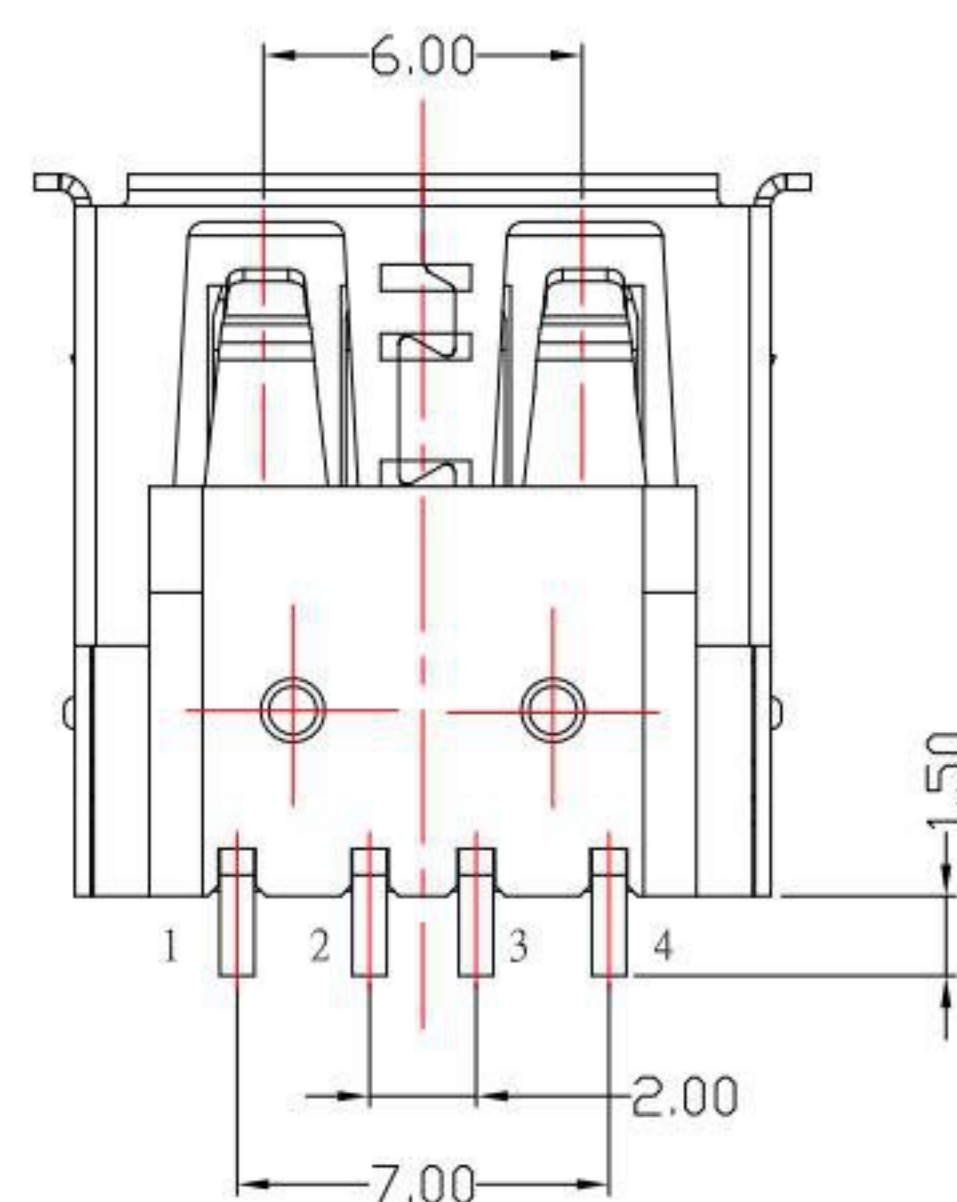
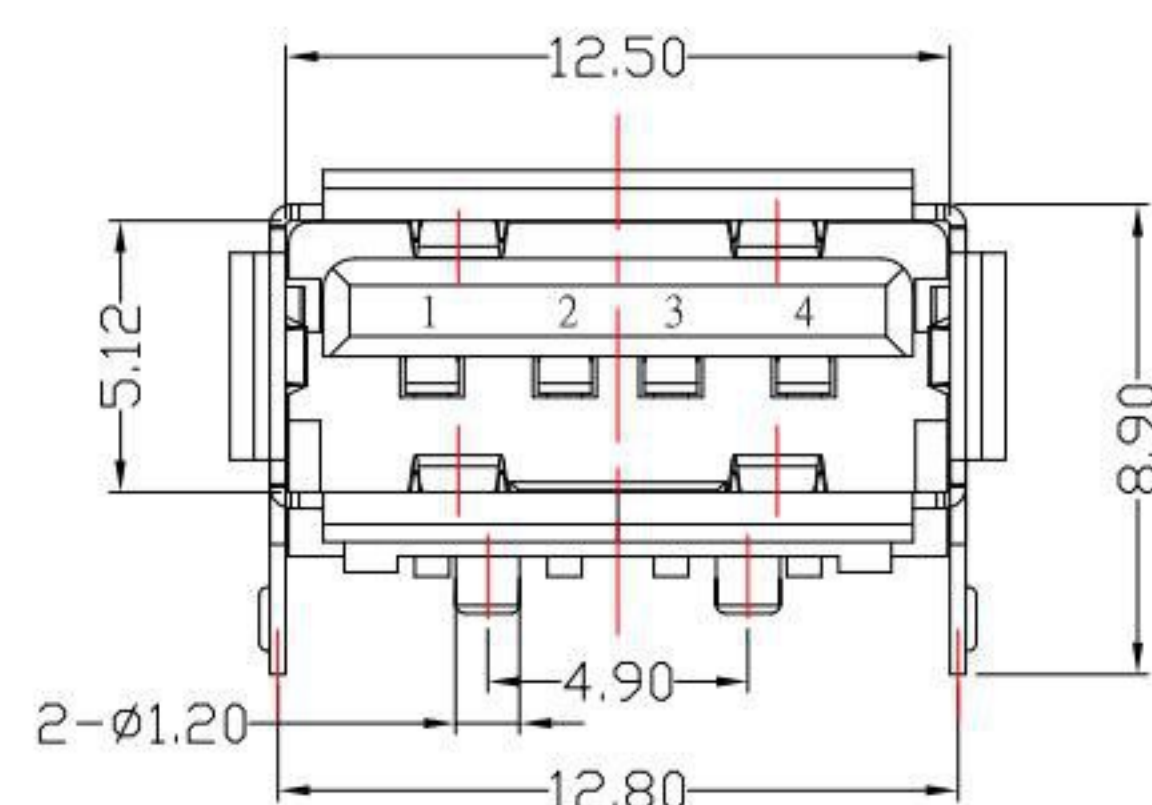
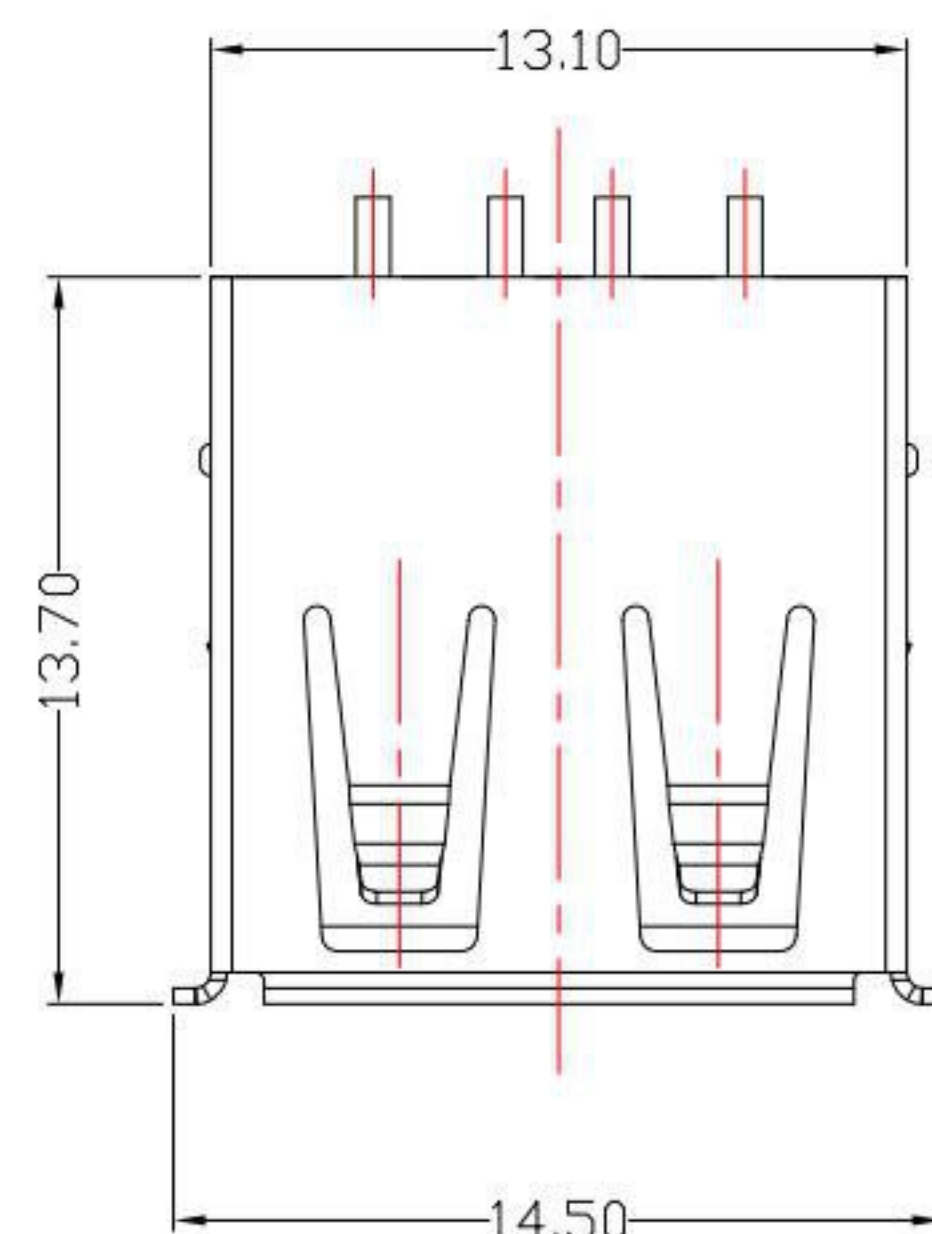
Blank : BRASS

I : SPCC

Color :

White : W

Black : B



RECOMMENDED PCB LAYOUT

SPECIFICATIONS

Electrical:

- 1.Contact Resistance: 30 mΩ Max
- 2.Insulation Resistance: 1,000 MΩ Min
- 3.Dielectric Withstanding Voltage: 500 V AC

Material:

- 1.Housing: LCP , UL 94V-0
- 2.Contact: Phosphor Bronze
- 3.Shell: Brass / SPCC

Finish:

- 1.Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- 2.Shell: Nickel under Plated surface layer

KSD 科斯达电子科技有限公司
SWITCH CONNECTOR 全球互联零组件制造企业
KSD ELECTRONIC TECHNOLOGY Co., LTD

TOLERANCE UNLESS OTHERWISE STATED :
Up to 5 ±0.2
Above 5 ~ 15 ±0.3
Above 15 ~ 30 ±0.4
Above 30 ~ 50 ±0.5
Angle ±0.3°
3RD. ANGEL'S
UNITS MM

DRAWN BY: DATE

Jack Lu 07/21/20

CHECKED BY: DATE

Jacky Chen 07/21/20

APPROVED BY: DATE

Tony Kao 07/21/20

MAT'L	TITLE	CONNECTOR
FINISH	MODLE	USB A/F SMT 外壳直脚 有柱
SCALE	DWG NO.	SUA-110M4x-x-S235
SHEET NO.	PART NO.	SUA-110M4x-x-S235

ITEM NO.	DESCRIPTION	DRAWN	DATE
3	新增PIN编号	Jack	072120
2	新增PCB LAYOUT尺寸	Jack	072020
1	新增平整度标示	Jack	052518